

Title (en)
CO-MOLDED FLOCK TRANSFER AND METHOD

Title (de)
AUS MEHREREN KOMPONENTEN SPRITZGEGOSSENES FLOCKENÜBERTRAGUNGSBLATT UND VERFAHREN

Title (fr)
TRANSFERT FLOQUE CO-MOULE ET PROCEDE

Publication
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Application
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Priority
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Abstract (en)
[origin: WO0209925A1] A method of providing a molding article with a plush surface is provided. The method includes providing a flocked transfer (2), securing the transfer (2) in place in a mold (4), and molding the article such that the transfer (2) is embedded in the surface of the article. The article can be injection molded.

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Citation (search report)
• [X] JP H01266284 A 19891024 - MOLTEN CORP
• [X] DE 3004560 A1 19810813 - ALKOR GMBH [DE]
• [X] JP H01310947 A 19891215 - KAWAGUCHI GOSEI KK
• [X] JP H04126221 A 19920427 - TOPPAN PRINTING CO LTD
• [X] DD 202835 A3 19831005 - EHMS EBERHARD, et al
• See also references of WO 0209925A1

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WO 0209925 A1 20020207; AU 2001277991 B2 20060615; AU 7799101 A 20020213; CN 1280081 C 20061018; CN 1455724 A 20031112; EP 1311380 A1 20030521; EP 1311380 A4 20090610; JP 2005503936 A 20050210; JP 5220977 B2 20130626; KR 100794604 B1 20080114; KR 20060103964 A 20061009; US 6929771 B1 20050816

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